

GENERAL DESCRIPTION

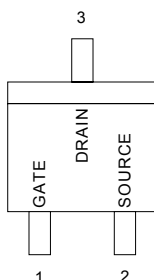
This N-Channel enhancement mode field effect transistor is produced using high cell density, DMOS technology. These products have been designed to minimize on-state resistance while provide rugged, reliable, and fast switching performance. It can be used in most applications requiring up to 115mA DC and can deliver pulsed currents up to 800mA. This product is particularly suited for low voltage, low current applications such as small servo motor control, power MOSFET gate drivers, and other switching applications.

FEATURES

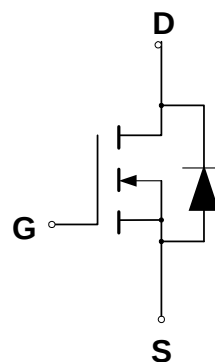
- ◆ High Density Cell Design for Low $R_{DS(ON)}$
- ◆ Voltage Controlled Small Signal Switch
- ◆ Rugged and Reliable
- ◆ High Saturation Current Capability

PIN CONFIGURATION

SOT-23
Top View



SYMBOL



N-Channel MOSFET

ORDERING INFORMATION

Part Number	Package
CMT2N7002	SOT-23
CMT2N7002G*	SOT-23

*Note: G : Suffix for Pb Free Product

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain Source Voltage	V_{DSS}	60	V
Drain-Gate Voltage ($R_{GS} = 1.0M\Omega$)	V_{DGR}	60	V
Drain to Current - Continuous	I_D	± 115	mA
- Pulsed	I_{DM}	± 800	
Gate-to-Source Voltage - Continue	V_{GS}	± 20	V
- Non-repetitive	V_{GSM}	± 40	V
Total Power Dissipation	P_D	225	mW
Derate above 25		1.8	mW/
Single Pulse Drain-to-Source Avalanche Energy - $T_J = 25$ ($V_{DD} = 50V$, $V_{GS} = 10V$, $I_{AS} = 0.8A$, $L = 30mH$, $R_G = 25\Omega$)	E_{AS}	9.6	mJ
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to 150	
Thermal Resistance - Junction to Ambient	θ_{JA}	417	/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	T_L	300	

ELECTRICAL CHARACTERISTICS

Unless otherwise specified, $T_J = 25^\circ\text{C}$.

		CMT2N7002			
Characteristic	Symbol	Min	Typ	Max	Units
Drain-Source Breakdown Voltage ($V_{GS} = 0\text{ V}$, $I_D = 10\text{ }\mu\text{A}$)	$V_{(BR)DSS}$	60			V
Drain-Source Leakage Current ($V_{DS} = 60\text{ V}$, $V_{GS} = 0\text{ V}$) ($V_{DS} = 60\text{ V}$, $V_{GS} = 0\text{ V}$, $T_J = 125^\circ\text{C}$)	I_{DSS}			1.0 0.5	μA mA
Gate-Source Leakage Current-Forward ($V_{gsf} = 20\text{ V}$)	I_{GSSF}			100	nA
Gate-Source Leakage Current-Reverse ($V_{gsf} = -20\text{ V}$)	I_{GSSF}			-100	nA
Gate Threshold Voltage * ($V_{DS} = V_{GS}$, $I_D = 250\text{ }\mu\text{A}$)	$V_{GS(th)}$	1.0		2.5	V
On-State Drain Current ($V_{DS} = 2.0 V_{DS(on)}$, $V_{GS} = 10\text{ V}$)	$I_{d(on)}$	500			mA
Static Drain-Source On-Resistance * ($V_{GS} = 10\text{ V}$, $I_D = 0.5\text{ A}$) ($V_{GS} = 10\text{ V}$, $I_D = 0.5\text{ A}$, $T_C = 125^\circ\text{C}$) ($V_{GS} = 5.0\text{ V}$, $I_D = 50\text{ mA}$) ($V_{GS} = 5.0\text{ V}$, $I_D = 50\text{ mA}$, $T_C = 125^\circ\text{C}$)	$R_{DS(on)}$			7.5 13.5 7.5 13.5	Ω
Drain-Source On-Voltage * ($V_{GS} = 10\text{ V}$, $I_D = 0.5\text{ A}$) ($V_{GS} = 5.0\text{ V}$, $I_D = 50\text{ mA}$)	$V_{DS(on)}$			3.75 0.375	V
Forward Transconductance ($V_{DS} = 2.0 V_{DS(on)}$, $I_D = 200\text{ mA}$) *	g_{FS}	80			mmhos
Input Capacitance	$(V_{DS} = 25\text{ V}$, $V_{GS} = 0\text{ V}$, $f = 1.0\text{ MHz}$)	C_{iss}		50	pF
Output Capacitance		C_{oss}		25	pF
Reverse Transfer Capacitance		C_{rss}		5.0	pF
Turn-On Delay Time	$(V_{DD} = 25\text{ V}$, $I_D = 500\text{ mA}$, $V_{gen} = 10\text{ V}$, $R_G = 25\Omega$, $R_L = 50\Omega$) *	$t_{d(on)}$		20	ns
Turn-Off Delay Time		$t_{d(off)}$		40	ns
Diode Forward On-Voltage ($I_S = 115\text{ mA}$, $V_{GS} = 0\text{ V}$)	V_{SD}			-1.5	V
Source Current Continuous (Body Diode)	I_S			-115	mA
Source Current Pulsed	I_{SM}			-800	mA

* Pulse Test: Pulse Width 300 μs , Duty Cycle 2%

TYPICAL ELECTRICAL CHARACTERISTICS

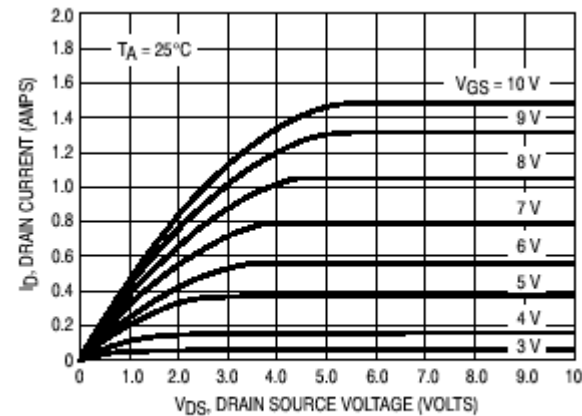


Figure 1. Ohmic Region

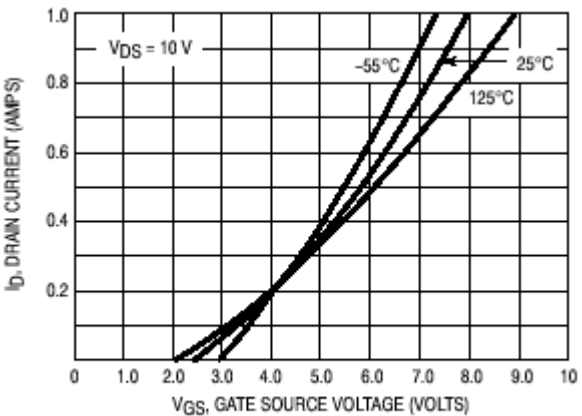


Figure 2. Transfer Characteristics

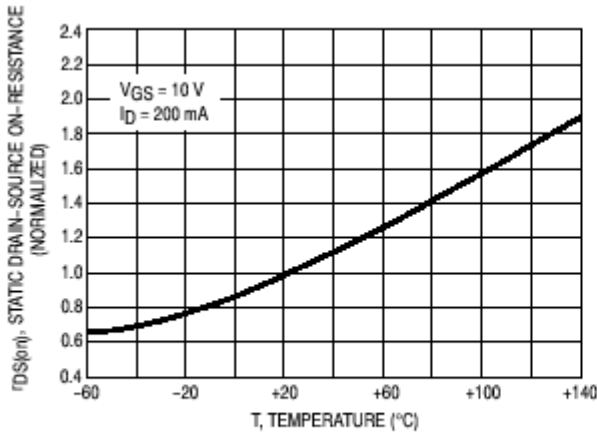


Figure 3. Temperature versus Static Drain-Source On-Resistance

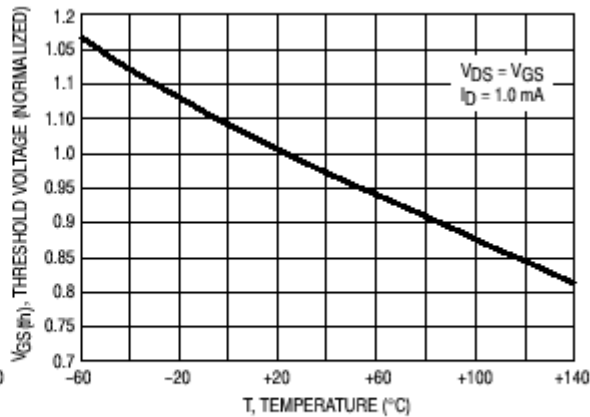


Figure 4. Temperature versus Gate Threshold Voltage

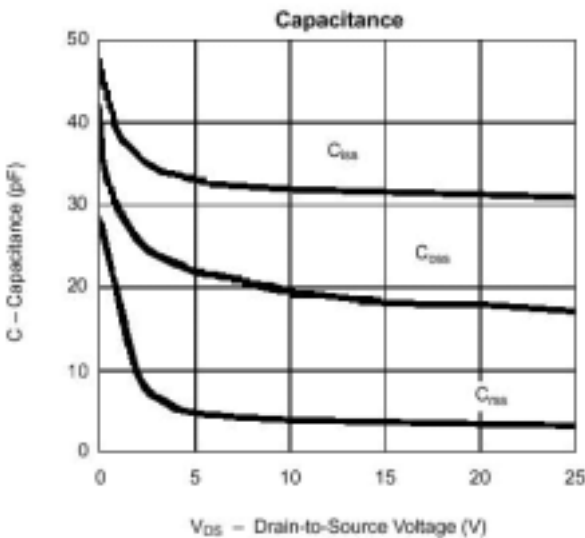
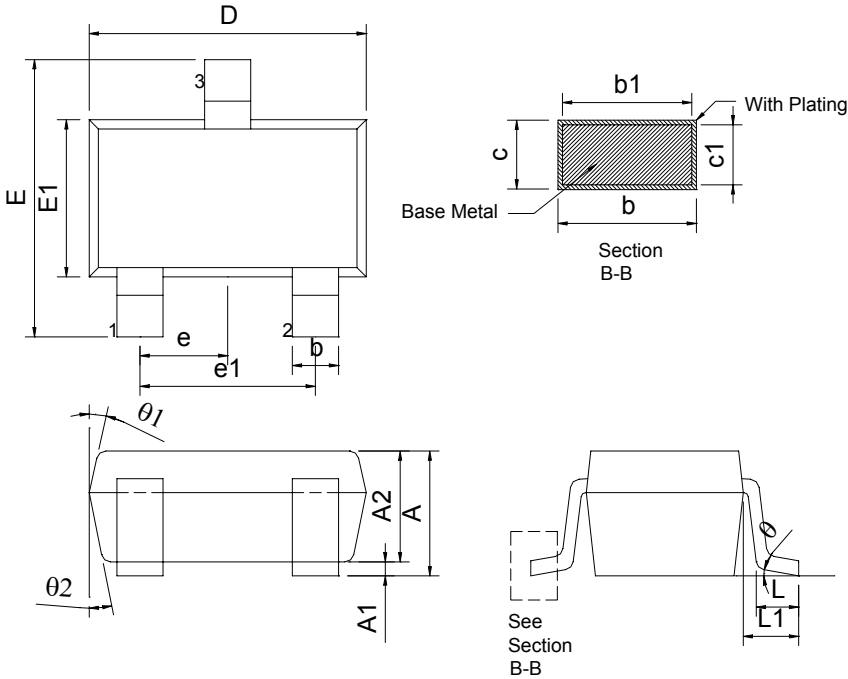


Figure 5. Capacitance

PACKAGE DIMENSION

SOT-23



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.05	---	1.35	0.041	---	0.053
A1	0.05	---	0.15	0.002	---	0.006
A2	1.00	1.10	1.20	0.039	0.043	0.047
b	0.25	---	0.50	0.010	---	0.020
b1	0.25	0.40	0.45	0.010	0.016	0.018
c	0.08	---	0.20	0.003	---	0.008
c1	0.08	0.11	0.15	0.003	0.004	0.006
D	2.70	2.90	3.00	0.106	0.114	0.118
E	2.20	2.40	2.60	0.087	0.094	0.102
E1	1.20	1.30	1.40	0.047	0.051	0.055
L	0.35	0.45	0.55	0.014	0.018	0.022
L1	0.60 REF			0.024 REF		
e	0.95 BSC			0.037 BSC		
e1	1.90 BSC			0.075 BSC		
θ	0°	5°	10°	0°	5°	10°
θ_1	3°	5°	7°	3°	5°	7°
θ_2	6°	8°	10°	6°	8°	10°